



# AO4435

## 30V P-Channel MOSFET

### General Description

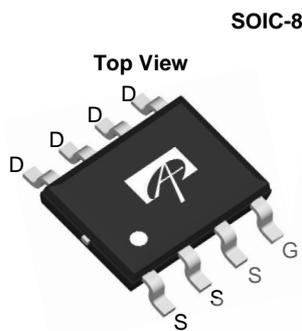
The AO4435 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , and ultra-low low gate charge with a 25V gate rating. This device is suitable for use as a load switch or in PWM applications.

- RoHS Compliant
- AO4435 is Halogen Free

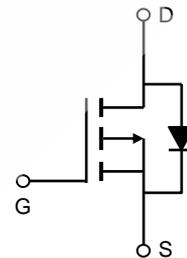
### Product Summary

$V_{DS} = -30V$   
 $I_D = -10.5A$  ( $V_{GS} = -20V$ )  
 $R_{DS(ON)} < 14m\Omega$  ( $V_{GS} = -20V$ )  
 $R_{DS(ON)} < 18m\Omega$  ( $V_{GS} = -10V$ )  
 $R_{DS(ON)} < 36m\Omega$  ( $V_{GS} = -5V$ )

100% UIS Tested  
 100% Rg Tested



Bottom View



### Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	$V_{DS}$	-30	V
Gate-Source Voltage	$V_{GS}$	$\pm 25$	V
Continuous Drain Current <sup>A</sup>	$I_D$	$T_A=25^\circ C$	-10.5
		$T_A=70^\circ C$	-8
Pulsed Drain Current <sup>B</sup>	$I_{DM}$	-80	A
Power Dissipation <sup>A</sup>	$P_D$	$T_A=25^\circ C$	3.1
		$T_A=70^\circ C$	2.0
Avalanche Current <sup>B</sup>	$I_{AR}$	-20	A
Repetitive avalanche energy 0.3mH <sup>B</sup>	$E_{AR}$	60	mJ
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	$^\circ C$

### Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient <sup>A</sup>	$R_{\theta JA}$	$t \leq 10s$	32	$^\circ C/W$
		Steady State	60	$^\circ C/W$
Maximum Junction-to-Lead <sup>C</sup>	$R_{\theta JL}$	17	24	$^\circ C/W$

Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>STATIC PARAMETERS</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$I_D = -250\mu\text{A}, V_{GS} = 0\text{V}$	-30			V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = -30\text{V}, V_{GS} = 0\text{V}$ $T_J = 55^\circ\text{C}$			-1 -5	$\mu\text{A}$
$I_{GSS}$	Gate-Body leakage current	$V_{DS} = 0\text{V}, V_{GS} = \pm 25\text{V}$			$\pm 100$	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250\mu\text{A}$	-1.7	-2.3	-3	V
$I_{D(ON)}$	On state drain current	$V_{GS} = -10\text{V}, V_{DS} = -5\text{V}$	-80			A
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS} = -20\text{V}, I_D = -11\text{A}$ $T_J = 125^\circ\text{C}$		11	14	m $\Omega$
		$V_{GS} = -10\text{V}, I_D = -10\text{A}$		15	19	
		$V_{GS} = -5\text{V}, I_D = -5\text{A}$		15	18	
		$V_{GS} = -5\text{V}, I_D = -5\text{A}$		27	36	
$g_{FS}$	Forward Transconductance	$V_{DS} = -5\text{V}, I_D = -10\text{A}$		22		S
$V_{SD}$	Diode Forward Voltage	$I_S = -1\text{A}, V_{GS} = 0\text{V}$		-0.74	-1	V
$I_S$	Maximum Body-Diode Continuous Current				-3.5	A
<b>DYNAMIC PARAMETERS</b>						
$C_{iss}$	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=-15\text{V}, f=1\text{MHz}$		1130	1400	pF
$C_{oss}$	Output Capacitance			240		pF
$C_{rss}$	Reverse Transfer Capacitance			155		pF
$R_g$	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$	1	5.8	8	$\Omega$
<b>SWITCHING PARAMETERS</b>						
$Q_{g(10V)}$	Total Gate Charge	$V_{GS}=-10\text{V}, V_{DS}=-15\text{V}, I_D=-10\text{A}$		18	24	nC
$Q_{g(4.5V)}$	Total Gate Charge			9.5		
$Q_{gs}$	Gate Source Charge			5.5		nC
$Q_{gd}$	Gate Drain Charge			3.3		nC
$t_{D(on)}$	Turn-On DelayTime			8.7		ns
$t_r$	Turn-On Rise Time	$V_{GS}=-10\text{V}, V_{DS}=-15\text{V}, R_L=1.5\Omega,$ $R_{GEN}=3\Omega$		8.5		ns
$t_{D(off)}$	Turn-Off DelayTime			18		ns
$t_f$	Turn-Off Fall Time			7		ns
$t_{rr}$	Body Diode Reverse Recovery Time	$I_F=-10\text{A}, dI/dt=100\text{A}/\mu\text{s}$		25	30	ns
$Q_{rr}$	Body Diode Reverse Recovery Charge	$I_F=-10\text{A}, dI/dt=100\text{A}/\mu\text{s}$		12		nC

A: The value of  $R_{\theta JA}$  is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ . The value in any given application depends on the user's specific board design. The current rating is based on the  $t \leq 10\text{s}$  thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C: The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to lead  $R_{\theta JL}$  and lead to ambient.

D: The static characteristics in Figures 1 to 6 are obtained using  $<300\mu\text{s}$  pulses, duty cycle 0.5% max.

E: These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The SOA curve provides a single pulse rating.

F: The current rating is based on the  $t \leq 10\text{s}$  thermal resistance rating.

G:  $E_{AR}$  and  $I_{AR}$  ratings are based on low frequency and duty cycles to keep  $T_J=25^\circ\text{C}$ .

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

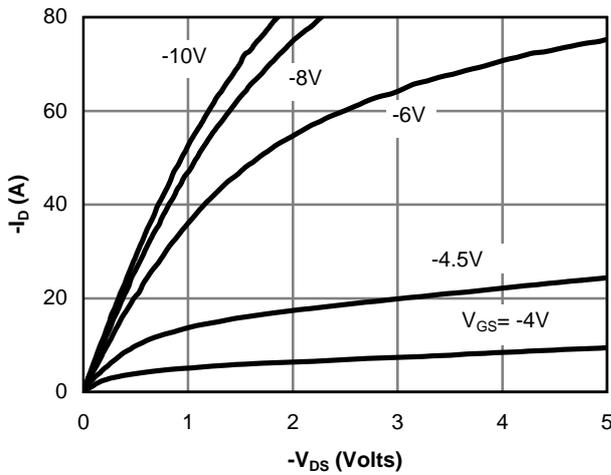


Figure 1: On-Region Characteristics

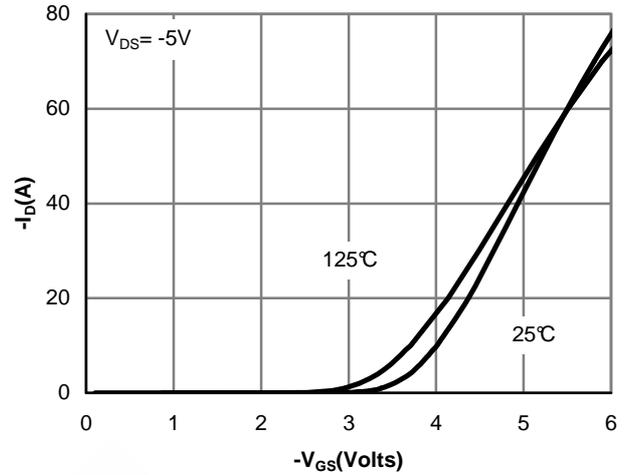


Figure 2: Transfer Characteristics

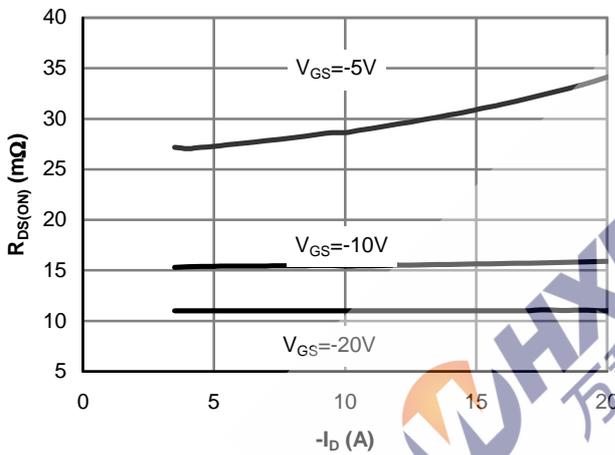


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

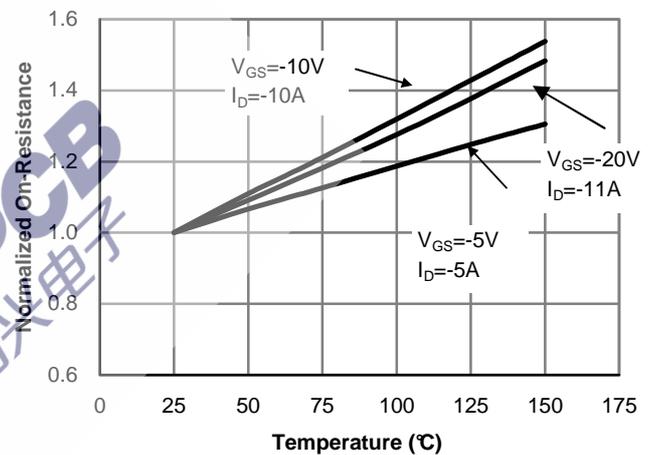


Figure 4: On-Resistance vs. Junction Temperature

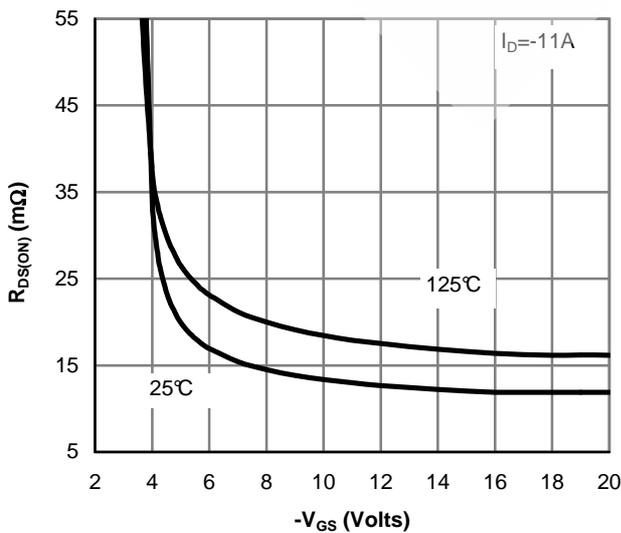


Figure 5: On-Resistance vs. Gate-Source Voltage

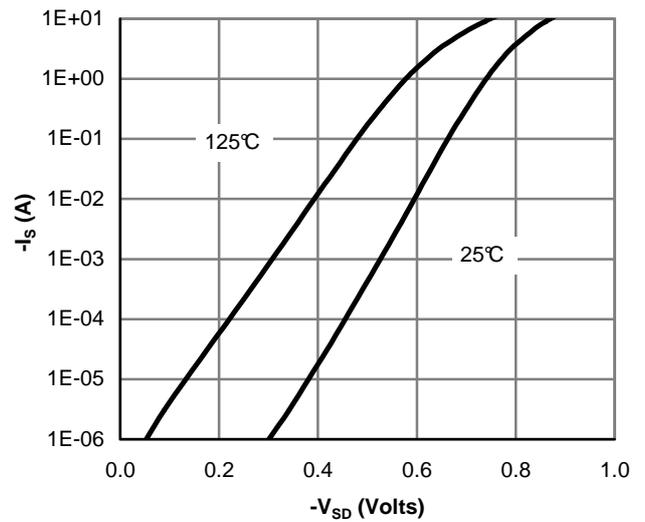


Figure 6: Body-Diode Characteristics

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

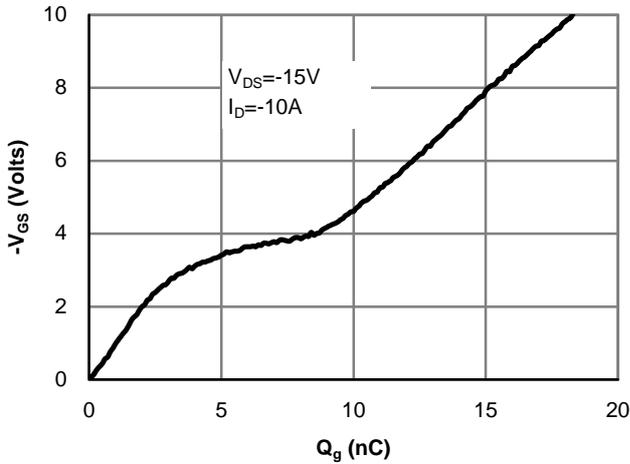


Figure 7: Gate-Charge Characteristics

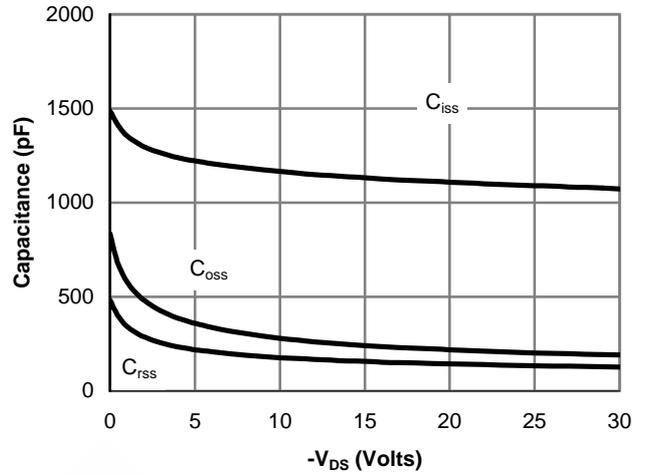


Figure 8: Capacitance Characteristics

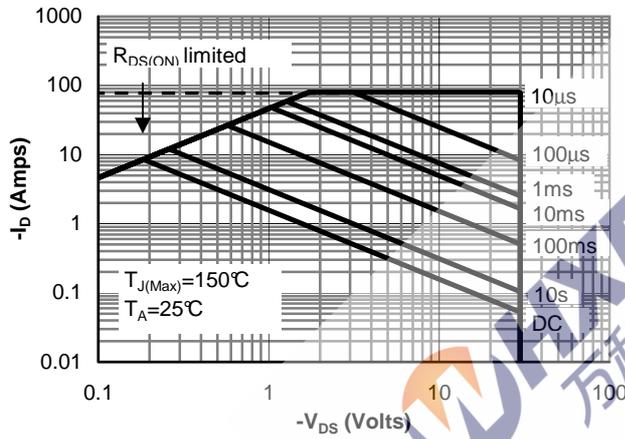


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

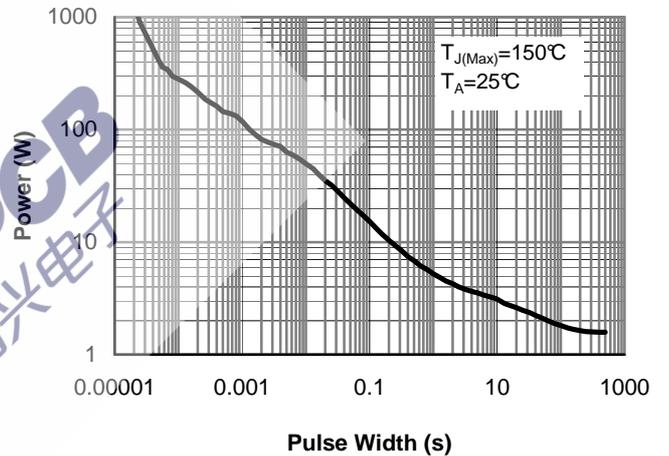


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

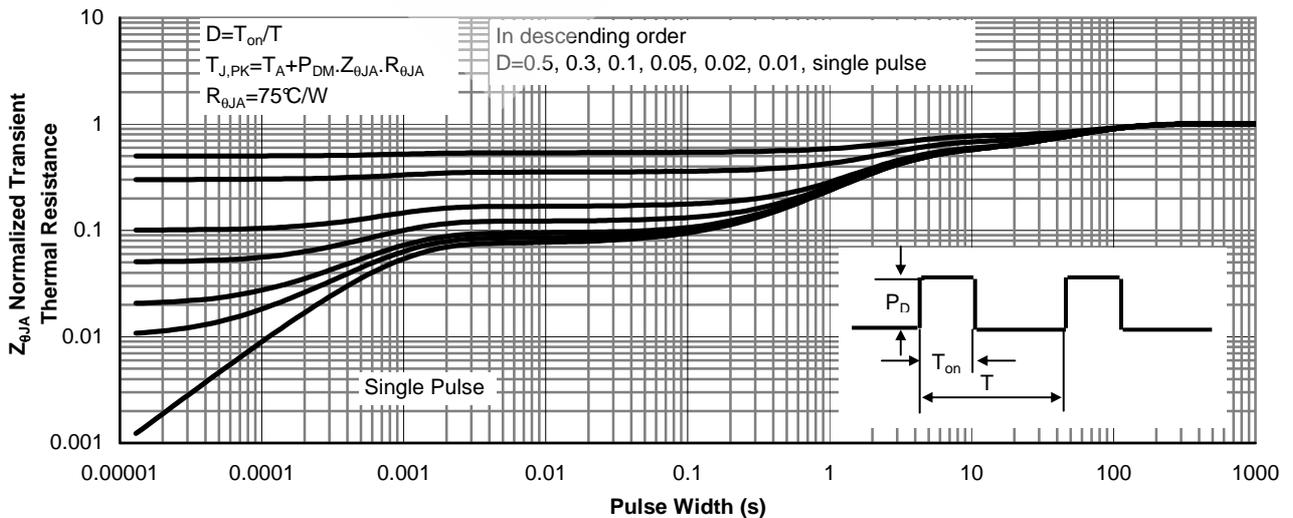
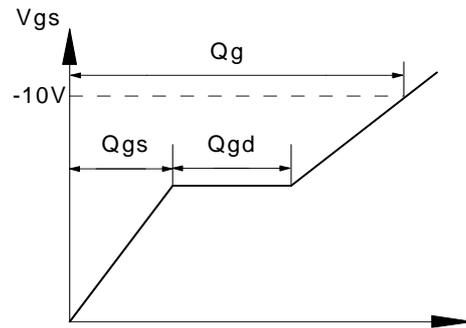
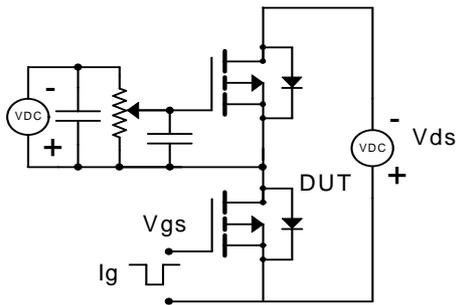
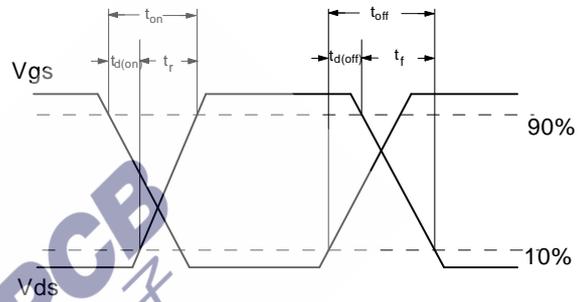
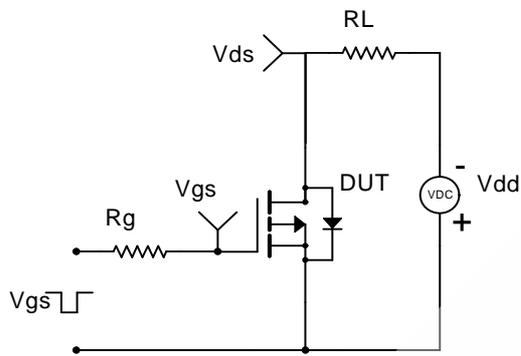


Figure 11: Normalized Maximum Transient Thermal Impedance (Note E)

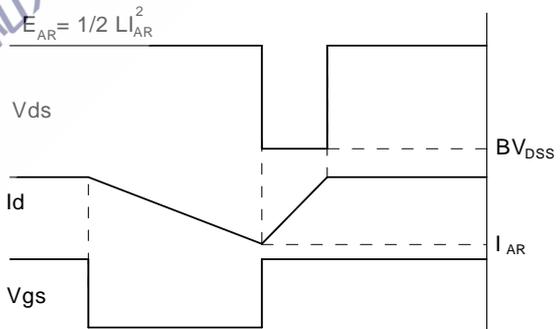
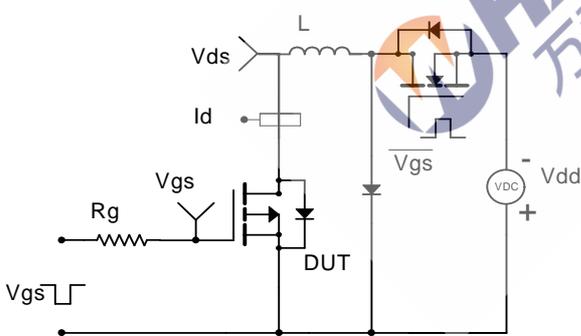
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms

